



HW-15-08-G-S-335-SM



OPTION



HW-SM SERIES

(2.54 mm) .100"

BLE .025" SQ BOARD STACKERS

Board Mates:

SSW, SSQ, ESW, ESQ, CES, SLW, BSW, BCS, SSM, HLE, PHF

Cable Mates:

IDSS, IDSD

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?HW-SM

Insulator Material:

Top: Natural LCP Bottom: Black I CP Terminal Material: Phosphor Bronze Plating: Au or Sn over Au or Sil over 50 μ" (1.27 μm) Ni Operating Temp Range: -55 °C to +125 °C with Gold -55 °C to +105 °C with Tin RoHS Compliant:

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity:

(0.15 mm) .006" max* *(.004" stencil solution may be available; contact IPG@samtec.com)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



ALSO AVAILABLE (MOQ Required)

- · Other platings
- · Locking Clip (Manual placement required) available with double row -SM

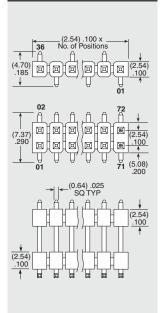
Notes:

For added mechanical stability, Samtec recommends mechanical board spacers be used in applications with gold or selective gold plated connectors. Contact ipg@samtec.com for more information.

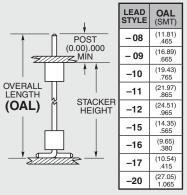
This Series is non-standard, non-returnable.



02 thru 36



Specify LEAD STYLE from chart



ROW STACKER OPTION **HEIGHT**

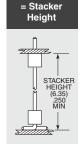
"XXX"





=Single Row

- D =Double Row



= Polarized

Specify omitted pin position

= Alignment Pin (Metal or plastic at Samtec discretion)

–TR = Tape & Reel Packaging (4–27 pins per row only) (Not Available on Lead Styles 10, 11, 12 & 20)

= Gold flash on contact, Matte Tin on tail

= 10 $\mu^{\text{\tiny{II}}}$ (0.25 $\mu m)$ Gold on contact area of longer tail, Matte Tin on tail

-G= 10 μ" (0.25 μm) Gold on contact area of longer tail, Gold flash on balance

= Matte Tin

Due to technical progress, all designs, specifications and components are subject to change without notice